

# CMPA1D1E025F

25 W, 13.75 - 14.5 GHz, 40 V, Ku-Band GaN MMIC, Power Amplifier

PN: CMPA1D1E025F Package Type: 440213

#### **Description**

The CMPA1D1E025F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC) on a silicon carbide (SiC) substrate, using a 0.25 μm gate length fabrication process. The Ku-Band 25W MMIC is targeted for commercial Ku-Band satellite communications applications. It offers high gain and superior efficiency while meeting OQPSK linearity required for Satcom applications at 3dB backed off P<sub>SAT</sub> operations. This Ku-Band MMIC is available in a 10 lead, 25 mm x 9.9 mm metal/ceramic flanged package.

#### Typical Performance Over 13.75-14.5 GHz ( $T_c = 25^{\circ}$ C)

Parameter	13.75 GHz	14.0 GHz	14.25 GHz	14.5 GHz	Units
Small Signal Gain	24	24.5	24.5	24	dB
Linear Output Power	24	23	21	20	W
Power Gain	21	21	20	20	dB
Power Added Efficiency	22	20	18	18	%

#### Note:

#### **Features**

- 24 dB Small Signal Gain
- 40 W Typical Pulsed PSAT
- Operation up to 40 V
- 20 W linear power under OQPSK
- Class A/B high gain, high efficiency 50 ohm MMIC Ku-Band high power amplifier

#### **Applications**

Satellite Communication Uplink



<sup>&</sup>lt;sup>1</sup> Measured at -30 dBc, 1.6 MHz from carrier, in the CMPA1D1E025F-AMP under OQPSK modulation, 1.6 Msps, PN23, Alpha Filter = 0.2



### **Absolute Maximum Ratings (not simultaneous)**

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	V <sub>DSS</sub>	120	V	2500
Gate-source Voltage	V <sub>GS</sub>	-10, +2	$V_{DC}$	25°C
Power Dissipation	P <sub>DISS</sub>	94	W	
Storage Temperature	T <sub>STG</sub>	-55, +150	°C	
Operating Junction Temperature	TJ	225	, "(	
Maximum Forward Gate Current	I <sub>GMAX</sub>	10	mA	25°C
Soldering Temperature <sup>1</sup>	T <sub>s</sub>	245	°C	
Screw Torque	τ	40	in-oz	
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	°C/W	P <sub>DISS</sub> = 94 W, 85°C
Case Operating Temperature	T <sub>C</sub>	-40, +85	°C	CW, P <sub>DISS</sub> = 94 W

Note: Refer to the Application Note on soldering

#### Electrical Characteristics (Frequency = 13.75 GHz to 14.5 GHz unless otherwise stated; $T_c = 25$ °C)

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics <sup>1</sup>						
Gate Threshold	$V_{GS(th)}$	-3.4	-3.0	-2.6	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 18.2 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	_	-2.7	_	V	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 240 mA
Saturated Drain Current <sup>2</sup>	I <sub>DS</sub>	13.1	18.2	_	Α	V <sub>DS</sub> = 6.0 V, V <sub>GS</sub> = 2.0 V
Drain-Source Breakdown Voltage	$V_{BR}$	100	_	_	V	V <sub>GS</sub> = -8 V, I <sub>D</sub> = 18.2 mA
RF Characteristics <sup>3</sup>						
Small Signal Gain	S21	20.9	24	_		
Input Return Loss	S11	_	7	_	dB	$V_{DD} = 40 \text{ V}, I_{DQ} = 240 \text{ mA}, P_{IN} = -15 \text{ dBm}$
Output Return Loss	S22	_	-7	-6		
Output Mismatch Stress	VSWR	_	_	5:1	Ψ	No damage at all phase angles, $V_{DD} = 40 \text{ V}$ , $I_{DQ} = 240 \text{ mA}$ , $P_{OUT} = 41 \text{ dBm OQPSK}$

#### Notes:

<sup>&</sup>lt;sup>1</sup> Measured on-wafer prior to packaging

<sup>&</sup>lt;sup>2</sup> Scaled from PCM data

<sup>&</sup>lt;sup>3</sup> Measured in the CMPA1D1E025F-AMP



# **Electrical Characteristics Continued (T<sub>c</sub> = 25°C)**

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
RF Characteristics <sup>1,2,3,4</sup>						
Power Added Efficiency at 13.75 GHz	DAE	14.5	20.5	_	%	$V_{DD} = 40 \text{ V}, I_{DQ} = 240 \text{ mA}$
Power Added Efficiency at 14.5 GHz	PAE	12.5	18	_		
Power Gain at 13.75 GHz		19.25	23	_		
Power Gain at 14.5 GHz	$G_{P}$	17.75	22	_	dB	
OQPSK Linearity at 13.75 GHz	ACLD	_	-40	-32	ID	
OQPSK Linearity at 14.5 GHz	ACLR	_	-38	-30.5	dBc	

#### Notes:

### **Electrostatic Discharge (ESD) Classifications**

Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	НВМ	TBD	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	TBD	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C

<sup>&</sup>lt;sup>1</sup> Measured in the CMPA1D1E025F-AMP

<sup>&</sup>lt;sup>2</sup> Under OQPSK modulated signal, 1.6 Msps, PN23, Alpha Filter = 0.2

 $<sup>^{3}</sup>$  Measured at  $P_{AVE} = 41 \text{ dBm}$ 

<sup>&</sup>lt;sup>4</sup> Fixture loss de-embedded



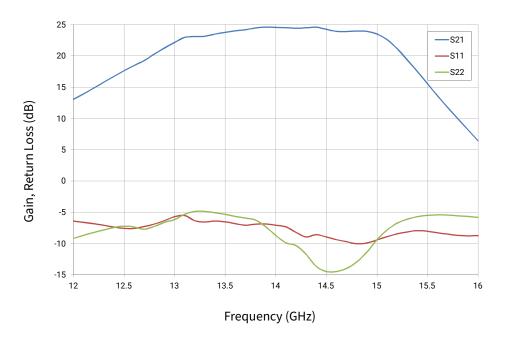


Figure 1. Small Signal S-Parameters CMPA1D1E025F in Test Fixture  $V_{DD}$  = 40 V,  $I_{DQ}$  = 240 mA,  $T_{CASE}$  = 25°C

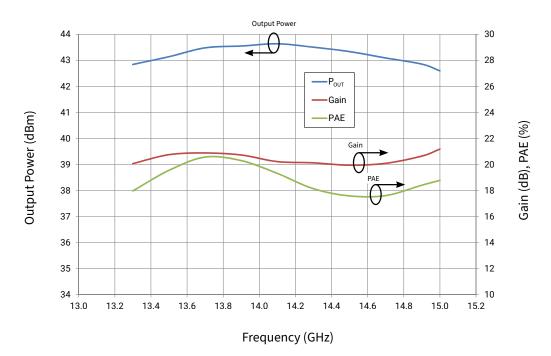


Figure 2. Modulated @ Spectral Regrowth = -30 dBc, 1.6 MHz from Carrier 1.6 Msps OQPSK Modulation  $V_{DD}$  = 40 V,  $I_{DQ}$  = 240 mA,  $T_{CASE}$  = 25°C



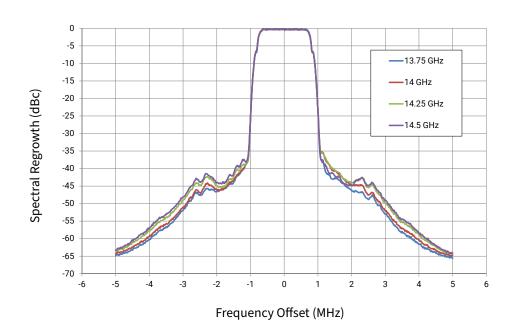


Figure 3. Spectral Mask @ Average Output Power = 41 dBm 1.6 Msps OQPSK Modulation  $V_{DD}$  = 40 V,  $I_{DQ}$  = 240 mA,  $T_{CASE}$  = 25°C

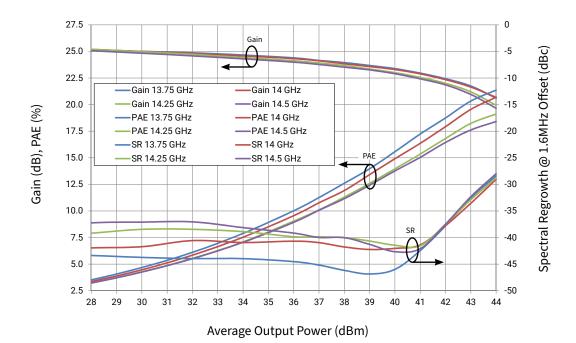
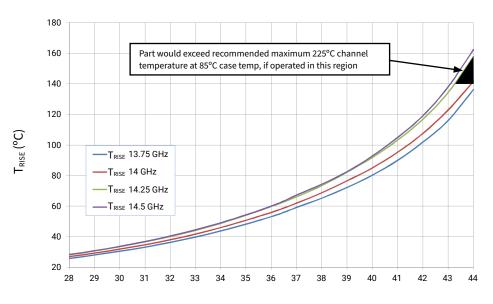


Figure 4. CMPA1D1E025F Modulated Power Sweep 1.6 Msps OQPSK Modulation  $V_{DD}$  = 40 V,  $I_{DQ}$  = 240 mA,  $T_{CASE}$  = 25°C





Average Output Power (dBm)

**Figure 5.** Modulated Power Sweep 1.6 Msps OQPSK Modulation  $V_{DD} = 40 \text{ V}, I_{DQ} = 240 \text{ mA}, T_{CASE} = 25^{\circ}\text{C}$ 

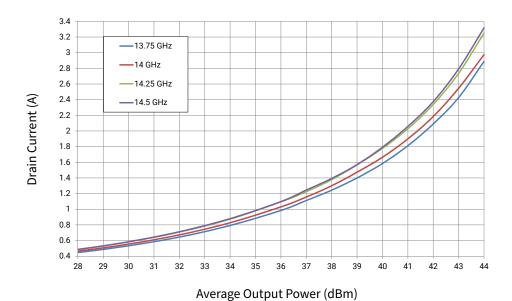


Figure 6. CMPA1D1E025F Modulated Power Sweep 1.6 Msps OQPSK Modulation  $V_{DD}$  = 40 V,  $I_{DQ}$  = 240 mA,  $T_{CASE}$  = 25°C



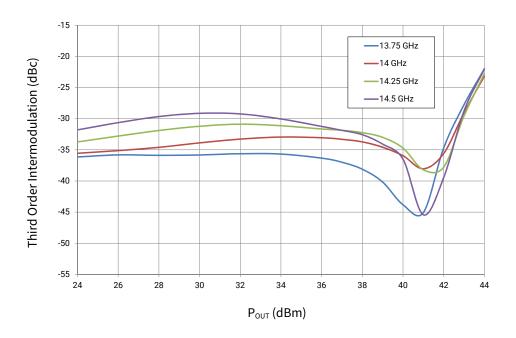
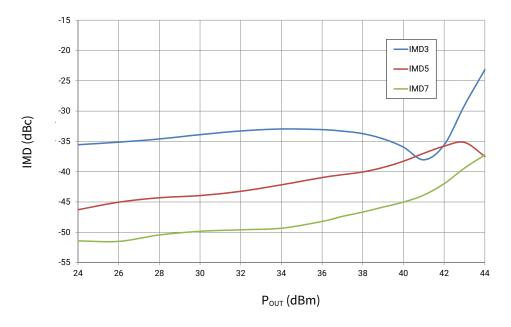


Figure 7. CMPA1D1E025F Two Tone Power Sweep IMD3 @ 1 MHz Carrier Spacing  $V_{DD} = 40 \text{ V}, I_{DQ} = 240 \text{ mA}, T_{CASE} = 25^{\circ}\text{C}$ 



**Figure 8.** Two Tone Power Sweep IMD @ 1 MHz Carrier Spacing, 14 GHz  $V_{DD} = 40 \text{ V}$ ,  $I_{DQ} = 240 \text{ mA}$ ,  $T_{CASE} = 25^{\circ}\text{C}$ 



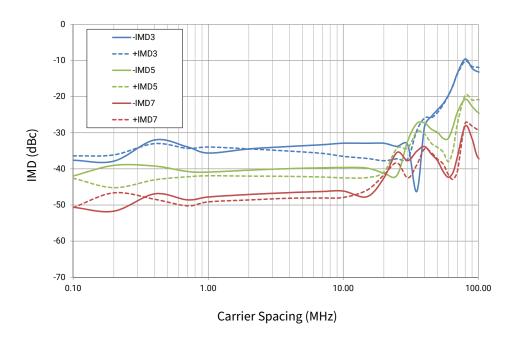
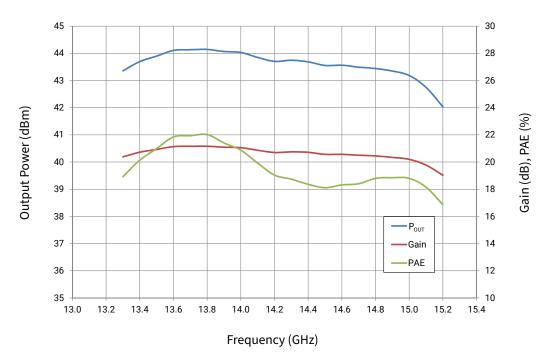


Figure 9. Two Tone Carrier Spacing Sweep @ 38 dBm Average Ouput Power, 14 GHz  $V_{DD}$  = 40 V,  $I_{DQ}$  = 1 A,  $T_{CASE}$  = 25°C



**Figure 10.** CW vs Frequency @  $P_{IN}$  = 23 dBm  $V_{DD}$  = 40 V,  $I_{DQ}$  = 240 mA,  $T_{CASE}$  = 25°C



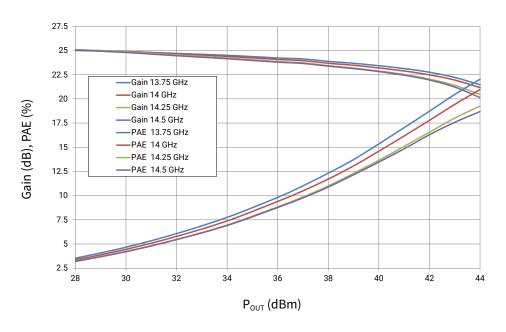
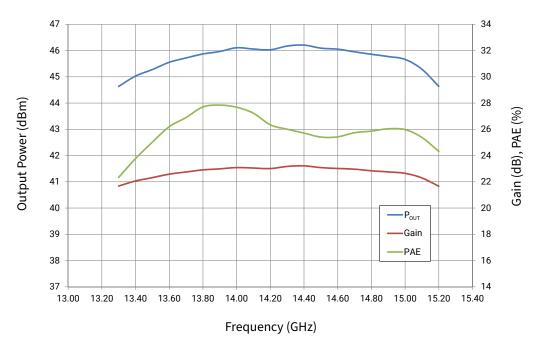


Figure 11. CW Power Sweep CMPA1D1E025F in Test Fixture  $V_{DD}$  = 40V,  $I_{DQ}$  = 240 mA,  $T_{CASE}$  = 25°C



**Figure 12.** Pulsed vs Frequency @  $P_{IN}$  = 23 dBm CMPA1D1E025F in Test Fixture  $V_{DD}$  = 40 V,  $I_{DQ}$  = 240 mA, 100 $\mu$ s Pulse Width, 10% Duty Cycle,  $T_{CASE}$  = 25°C



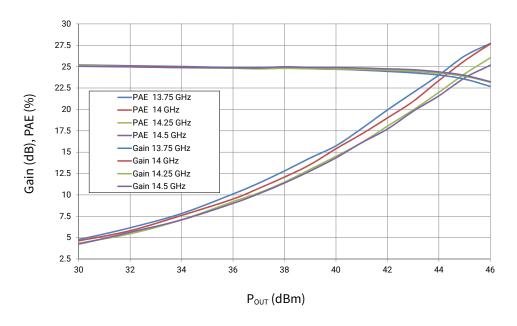


Figure 13. Pulsed Power Sweep CMPA1D1E025F in Test Fixture 10% Duty,  $100\mu s$  Pulse Width  $V_{DD}$  = 40V,  $I_{DQ}$  = 240 mA,  $T_{CASE}$  = 25°C

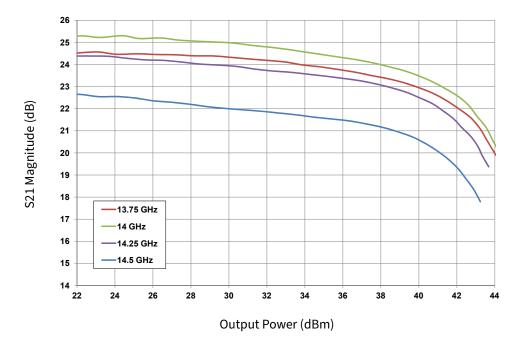


Figure 14. AM-AM  $V_{DD} = 40 \text{ V}, I_{DQ} = 240 \text{ mA}, T_{CASE} = 25^{\circ}\text{C}$ 



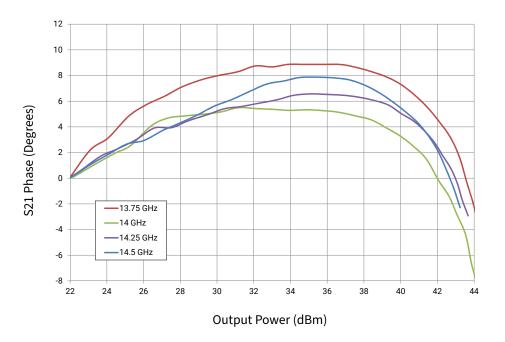


Figure 15. AM-PM  $V_{DD} = 40V$ ,  $I_{DQ} = 240$  mA,  $T_{CASE} = 25$ °C

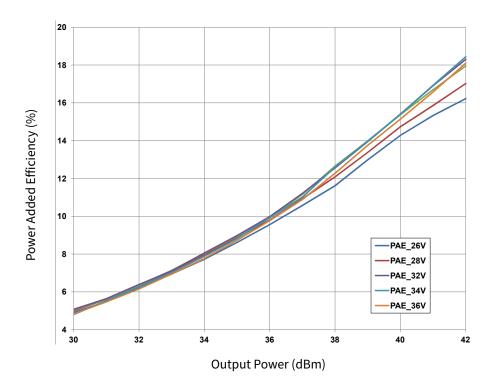
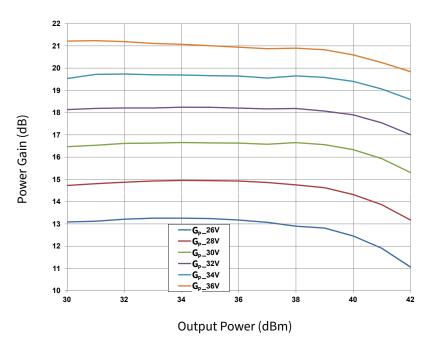


Figure 16. CMPA1D1E025F Modulated Power Sweep (PAE and  $G_P$ ) 1.6 Msps OQPSK Modulation, Frequency = 14 GHz  $V_{DD}$  = 26-36 V,  $I_{DQ}$  = 150 mA,  $T_{CASE}$  = 25°C





**Figure 17.** CMPA1D1E025F Modulated Power Sweep ( $G_P$ ) 1.6 Msps OQPSK Modulation, Frequency = 14 GHz  $V_{DD}$  = 26-36 V,  $I_{DQ}$  = 150 mA,  $T_{CASE}$  = 25°C

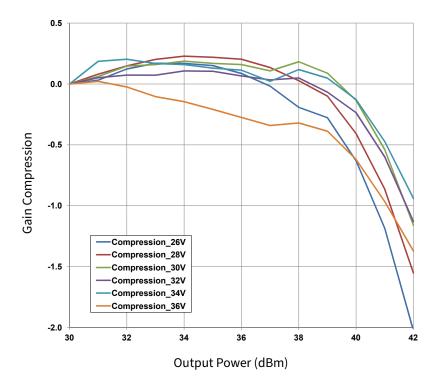
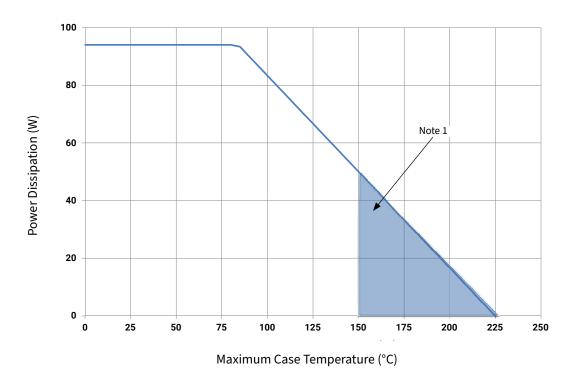


Figure 18. CMPA1D1E025F Modulated Power Sweep (Gain Compression) 1.6 Msps OQPSK Modulation, Frequency = 14 GHz  $V_{DD}$  = 26-36 V,  $I_{DQ}$  = 150 mA,  $T_{CASE}$  = 25°C



#### **CMPA1D1E025F Power Dissipation De-rating Curve**



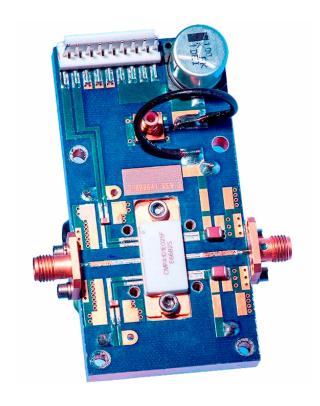
Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2)



#### **CMPA1D1E025F-AMP Demonstration Amplifier Circuit Bill of Materials**

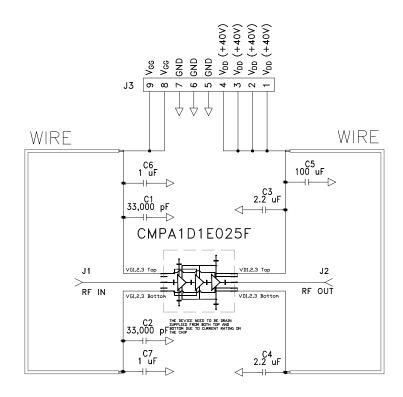
Designator	Description	Qty
C5	CAP ELECT 100μF 80V AFK SMD	1
C1, C2	CAP, 33000pF, 0805, 100V, X7R	2
C3, C4	CAP, 2.2μF, 100V, 10%, X7R, 1210	2
C6, C7	CAP, 1.0μF, 100V, 10%, X7R, 1210	2
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
J3	HEADER RT>PLZ .1CEN LK 9POS	1
W1, W2, W3	WIRE, BLACK, 22 AWG	1
	PCB, TEST FIXTURE, TACONICS RF35P, 20 MILS	1
	2-56 SOC HD SCREW 3/16 SS	4
-	#2 SPLIT LOCKWASHER SS	4
Q1	CMPA1D1E025F	1

### CMPA1D1E025F-AMP Demonstration Amplifier Circuit

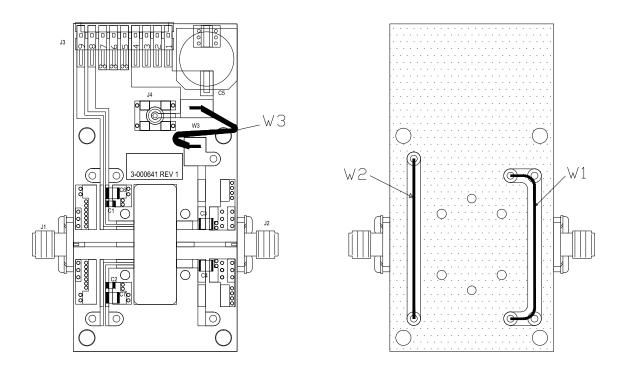




#### CMPA1D1E025F-AMP Demonstration Amplifier Circuit Schematic

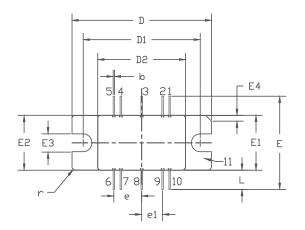


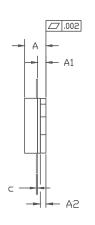
### **CMPA1D1E025F-AMP Demonstration Amplifier Circuit Outline**





# Product Dimensions CMPA1D1E025F (Package Type — 440213)





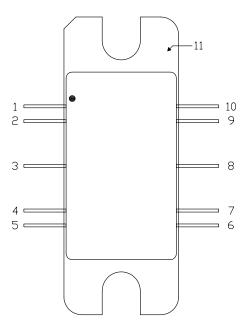
PIN 1: GATE BIAS 6: DRAIN BIAS 2: GATE BIAS 7: DRAIN BIAS 3: RF IN 8: RF DUT 4: GATE BIAS 9: DRAIN BIAS 5: GATE BIAS 10: DRAIN BIAS 11: SDURCE

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M 1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- 4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008' IN ANY DIRECTION.

					•
	INCHES		MILLIM	IETERS	NOTES
DIM	MIN	MAX	MIN	MAX	
Α	0.148	0.168	3.76	4.27	
A1	0.055	0.065	1.40	1.65	
A2	0.035	0.045	0.89	1.14	
b	0.01	TYP	0.254	TYP	10x
С	0.007	0.009	0.18	0.23	
D	0.995	1.005	25.27	25.53	
D1	0.835	0.845	21.21	21.46	
D2	0.623	0.637	15.82	16.18	
Ε	0.653	TYP	16.59	TYP	
E1	0.380	0.390	9.65	9.91	
E2	0.380	0.390	9.65	9.91	
E3	0.120	0.130	3.05	3.30	
E4	0.035	0.045	0.89	1.14	45° CHAMFER
е	0.20	) TYP	5.08 TYP		4x
e1	0.15	O TYP	3.81	TYP	4x
L	0.115	0.155	2.92	3.94	10x
r	0.02	5 TYP	.635	TYP	3x

Pin Number	Qty.
1	Gate Bias
2	NC
3	RF IN
4	NC
5	Gate Bias
6	Drain Bias
7	Dialli bias
8	RF OUT
9	Drain Bias
10	Diaili Dias
11	Source





#### **Part Number System**

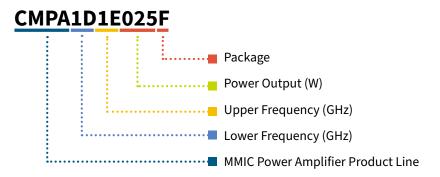


Table 1.

Parameter	Value	Units
Lower Frequency	13.75	GHz
Upper Frequency <sup>1</sup>	14.5	GHZ
Power Output	25	W
Package	Flange	_

#### Note:

Table 2.

Character Code	Code Value
A	0
В	1
С	2
D	3
E	4
F	5
G	6
Н	7
J	8
К	9
Examples	1A = 10.0 GHz 2H = 27.0 GHz

<sup>&</sup>lt;sup>1</sup> Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.



# **Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CMPA1D1E025F	GaN HEMT	Each	CNP A D/E025F
CMPA1D1E025F-AMP	Test board with GaN MMIC installed	Each	INDEADADA CONTRACTOR OF THE PARTY OF THE PAR



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